



**Conference and Exhibition
09 – 13 March 2020
ALPEXPO, Grenoble, France**

Call for Papers

Scope of the Event

The 23rd DATE conference and exhibition is the main European event bringing together designers and design automation users, researchers and vendors as well as specialists in hardware and software design, test and manufacturing of electronic circuits and systems. DATE puts strong emphasis on both technology and systems, covering ICs/SoCs, emerging technologies, embedded systems and embedded software.

Structure of the Event

The five-day event consists of a conference with plenary invited papers, regular papers, panels, hot-topic sessions, tutorials, workshops, special focus days and a track for executives. The scientific conference is complemented by a commercial exhibition showing the state-of-the-art in design and test tools, methodologies, IP and design services, reconfigurable and other hardware platforms, embedded software and (industrial) design experiences from different application domains, such as automotive, wireless, telecom and multimedia applications. The organization of user group meetings, fringe meetings, a university booth, a PhD forum, vendor presentations and social events offers a wide variety of extra opportunities to meet and exchange information on relevant issues for the design automation, design and test communities. Special space will also be allocated for EU-funded projects to show their results.

More details are available on the DATE website: www.date-conference.com.

Areas of Interest

Within the scope of the conference, the main areas of interest are: embedded systems, design methodologies, EDA algorithms and tools, testing of electronic circuits and systems, embedded software, application design and industrial design experiences. Topics of interest include, but are not restricted to:

- System Specification and Modelling
- System Design, Synthesis and Optimization
- Simulation and Validation
- Design of Low Power Systems
- Power Estimation and Optimization
- Green Computing Systems and Applications
- Temperature-Aware Design
- Temperature Modelling and Management
- Emerging Technologies for Computing Systems
- Emerging Memory Technologies and Applications
- Formal Methods and Verification
- Network-on-Chip
- Architectural and Microarchitectural Design
- Reconfigurable Computing
- Physical Design and Verification
- Analog and Mixed-Signal Circuits and Systems
- Interconnect and Packaging Modelling
- Communication, Consumer, and Multimedia Systems
- Transportation Systems
- Medical, Healthcare and Assistive Technology Systems
- Energy Generation, Recovery and Management Systems
- Secure Systems
- Reliable and Dependable Systems
- Test for Defects, Variability and Reliability
- Test Generation, Simulation and Diagnosis
- Test for Mixed-Signal, Analog, RF, MEMS
- Test Access, Design-for-Test, Test Compression, System Test
- On-Line Testing and Fault Tolerance
- Real-time and Networked Systems
- Compilers and Code Generation for Embedded Systems
- Model-based Design and Verification for Embedded Systems
- Embedded Software Architectures and Principles
- Software and Optimization for MPSoCs, Many-core, GPU-based or Heterogeneous Systems

Submission of Papers

All papers have to be submitted electronically by Sunday, 8 September 2019, via:
<https://www.date-conference.com/>

Papers can be submitted either for standard oral presentation or for interactive presentation.

The Program Committee also encourages proposals for Special Sessions, Tutorials, Friday Workshops, University Booth Demonstrations, PhD Forum and Exhibition Theatre.

Chairs

General Chair:

Giorgio Di Natale, CNRS/TIMA, FR
Email: giorgio.di-natale@univ-grenoble-alpes.fr

Programme Chair:

Cristiana Bolchini, Politecnico di Milano, IT
Email: cristiana.bolchini@polimi.it

Conference Organization

c/o K.I.T. Group GmbH Dresden
Bautzner Str. 117-119, 01099 Dresden, DE
Phone: +49 351 4967 312
Email: date@kitdresden.de